

REMARKS

It is suggested on page 3 of the office action that Kenny teaches a packaged integrated system including a re-combiner. The re-combiner is allegedly the element 1410 described at column 24, lines 48-58. It is suggested that the condensation area for fluid that is heated by the device 200 in the element 1410 constitutes a re-combiner.

A re-combiner is a device that reduces the buildup of gas in the cooling fluid pump by the pump 28. See present application at page 10, lines 16-21. Exposure of gases to the catalytic material 66 in the present application results in gas recombination.

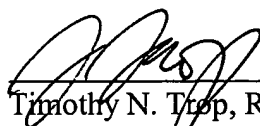
The cited reference to Kenny teaches an element 1410 which is merely a heat exchanger. The element 1410 is called a heat rejection element and is described at column 23, lines 40-45. There, it is explained that it may employ many different techniques for heat rejection including a design having a fluid flow path or paths throughout high surface-area structures such as fluid, channels, or fins. Plainly, the element 1410 is not a re-combiner.

Goodson does not teach a catalytic re-combiner that is provided within the packaged integrated system.

Therefore, there is no teaching of providing a re-combiner within the packaged integrated system. Reconsideration of the rejection is respectfully requested.

Respectfully submitted,

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